

AON2392

100V N-Channel AlphaSGT™

General Description

Trench Power AlphaSGT[™] technology

- Low R_{DS(ON)}
- Logic driven
- RoHS and Halogen-Free Compliant

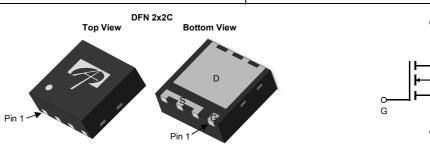
Product Summary

 $\begin{array}{lll} V_{DS} & 100V \\ I_{D} \; (at \, V_{GS} \! = \! 10V) & 8A \\ R_{DS(ON)} \, (at \, V_{GS} \! = \! 10V) & < 32m\Omega \\ R_{DS(ON)} \, (at \, V_{GS} \! = \! 4.5V) & < 39m\Omega \end{array}$

Applications

- Home Automation and IoT
- VOIP applications





Orderable Part Number	Package Type	Form	Minimum Order Quantity
AON2392	DFN2x2C	Tape & Reel	3000

Absolute	Maximum Ratings	T _A =25°C unless	othe	rwise	noted

Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V_{GS}	±20	V	
Continuous Drain Current	T _A =25°C		8		
	T _A =70°C	'D	6	Α	
Pulsed Drain Current ^C		I _{DM}	32		
	T _A =25°C	P _D	4.1	W	
Power Dissipation ^B	T _A =70°C	L D	2.6	VV	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C	

Thermal Characteristics					
Parameter	Symbol	Тур	Max	Units	
Maximum Junction-to-Ambient A t ≤ 10s	- R _{θJA}	25	30	°C/W	
Maximum Junction-to-Ambient AD Steady-State	PJA	45	55	°C/W	



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC I	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V		100			V
l 7	Zara Cata Valtara Drain Current	V _{DS} =100V, V _{GS} =0V				1	
I _{DSS}	Zero Gate Voltage Drain Current		T _J =55°C			5	μA
I_{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±20V				±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$		1.4	1.85	2.4	V
		V _{GS} =10V, I _D =8A			26	32	mΩ
$R_{DS(ON)}$	Static Drain-Source On-Resistance		T _J =125°C		46	57	
		V_{GS} =4.5V, I_D =6A			31	39	mΩ
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =8A			25		S
V_{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V			0.74	1	V
Is	Maximum Body-Diode Continuous Current					5	Α
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance				840		pF
Coss	Output Capacitance	V _{GS} =0V, V _{DS} =50V, f=1MHz			64		pF
C _{rss}	Reverse Transfer Capacitance				4		pF
R_g	Gate resistance	f=1MHz		1.4		Ω	
SWITCH	NG PARAMETERS	•	•		•	•	•
Q _g (10V)	Total Gate Charge	-V _{GS} =10V, V _{DS} =50V, I _D =8A			12.8	25	nC
Q _g (4.5V)	Total Gate Charge				6.1	12	nC
Q_{gs}	Gate Source Charge	V _{GS} -10V, V _{DS} -30V,	V _{GS} -10V, V _{DS} -30V, I _D -6A		2.1		nC
Q_{gd}	Gate Drain Charge]			1.8		nC
Q _{oss}	Output Charge	V_{GS} =0V, V_{DS} =50V	V _{GS} =0V, V _{DS} =50V		11		nC
t _{D(on)}	Turn-On DelayTime				7		ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =50V, R_L =5.85 Ω , R_{GEN} =3 Ω			8		ns
t _{D(off)}	Turn-Off DelayTime				24		ns
t _f	Turn-Off Fall Time				3		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =8A, di/dt=500A/μs			20		ns
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =8A, di/dt=500A/μs			70		nC

A. The value of R_{BJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The

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value in any given application depends on the user's specific board design. B. The power dissipation P_D is based on $T_{J(MAX)}$ =150° C, using \leq 10s junction-to-ambient thermal resistance. C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150° C. Ratings are based on low frequency and duty cycles to keep initialT₁=25° C.

D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JL}$ and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using $<300\mu s$ pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(MAX)}$ =150° C. The SOA curve provides a single pulse rating.



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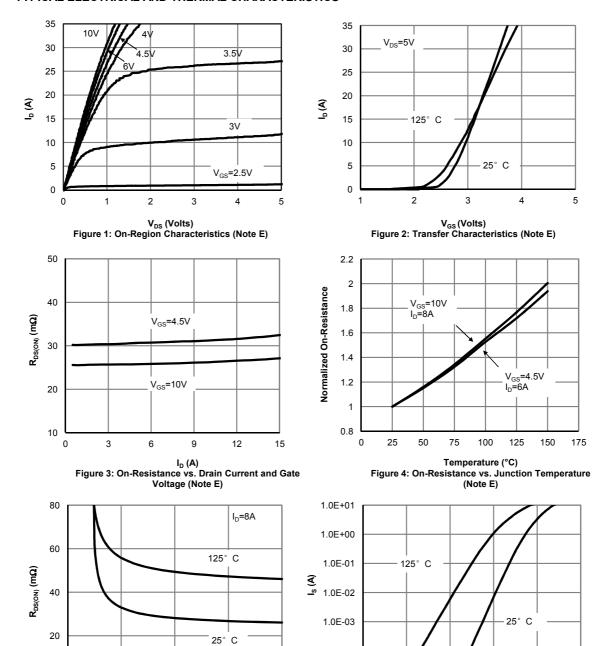
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6

V_{GS} (Volts)
Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



1.0E-04

1.0E-05

0.0

0.2

0.4

V_{SD} (Volts) Figure 6: Body-Diode Characteristics

(Note E)

0.6

0.8

1.0

10



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

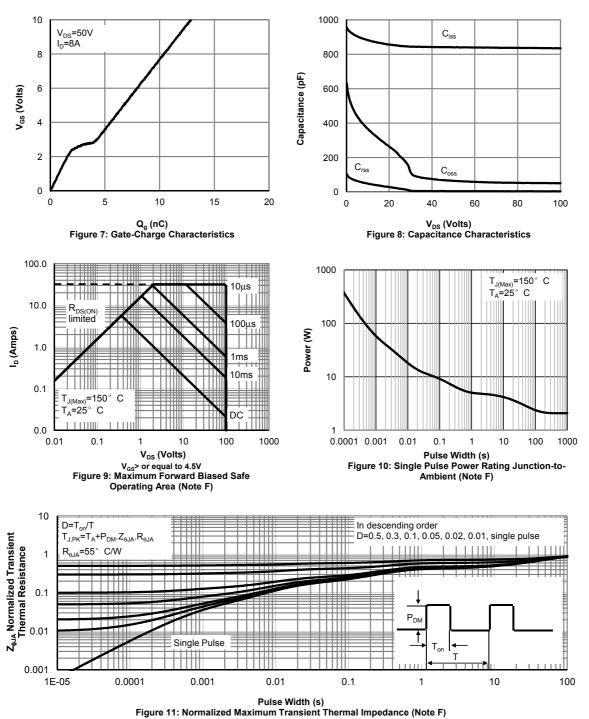


Figure A: Gate Charge Test Circuit & Waveforms

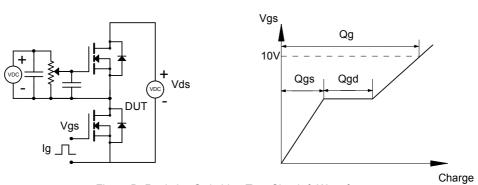


Figure B: Resistive Switching Test Circuit & Waveforms

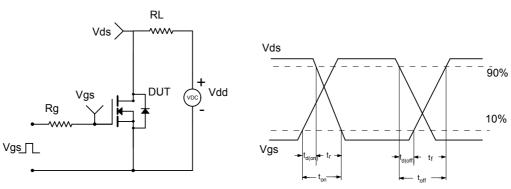


Figure C: Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

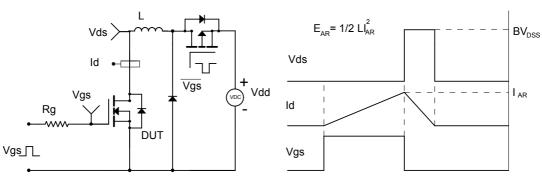
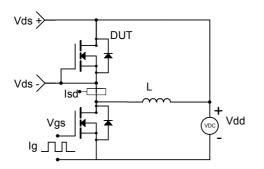
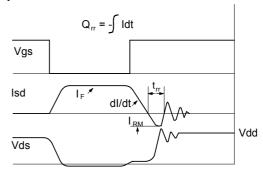


Figure D: Diode Recovery Test Circuit & Waveforms





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